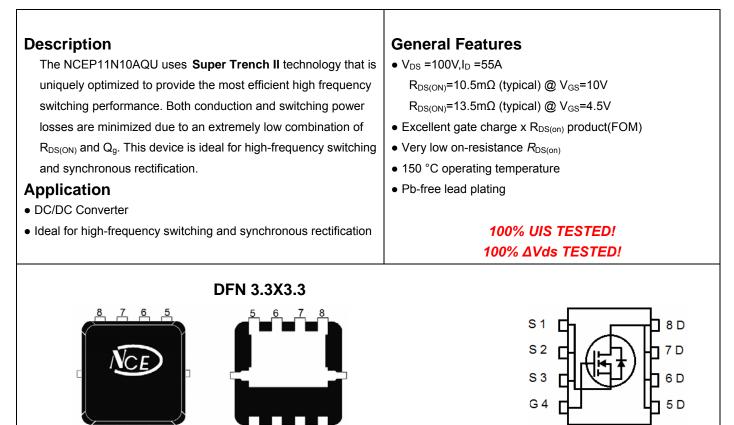


## NCE N-Channel Super Trench II Power MOSFET



Schematic Diagram

Quantity

## NCEP11N10AQU NCEP11N10AQU DFN3.3X3.3-8L

Package Marking and Ordering Information

Device

### Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

**Bottom View** 

**Device Package** 

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	100	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	I <sub>D</sub>	55	А
Drain Current-Continuous(T <sub>C</sub> =100°C)	I <sub>D</sub> (100℃)	39	А
Pulsed Drain Current	I <sub>DM</sub>	220	A
Maximum Power Dissipation	PD	70	W
Derating factor		0.56	W/℃
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	156	mJ
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 To 150	°C

**Reel Size** 

\_

Tape width

-

### **Thermal Characteristic**

່ 2 3 4 Top View

**Device Marking** 

Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	R <sub>θJC</sub>	1.79	°C/W	]
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## Electrical Characteristics (T<sub>c</sub>=25°C unless otherwise noted)

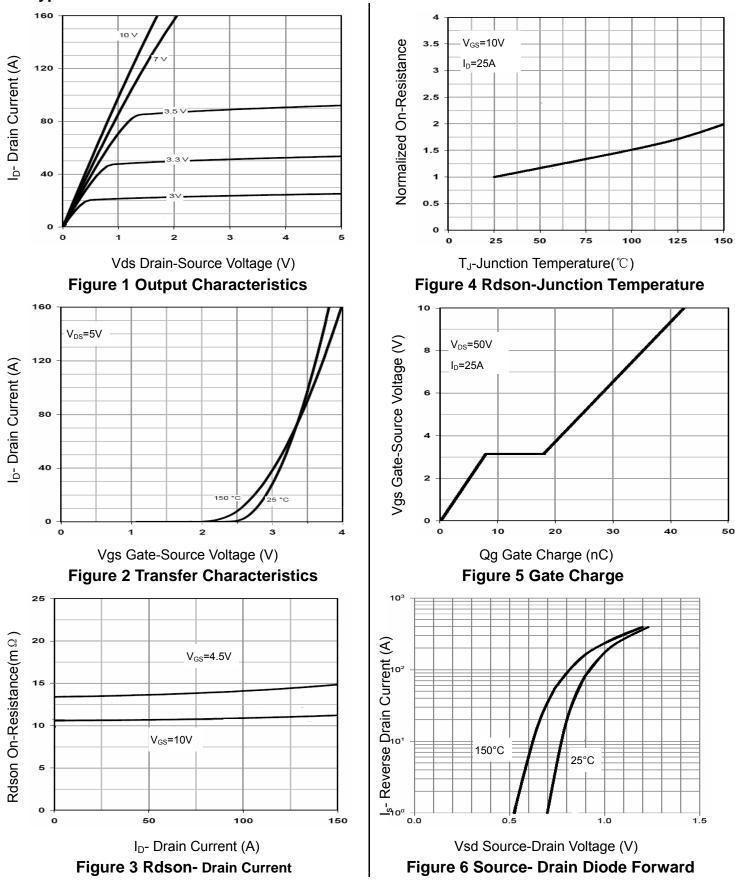
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	· · ·					•
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	100		-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =100V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	±100	nA
On Characteristics (Note 3)	· · ·					
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	1.1	1.8	2.5	V
	D	$V_{GS}$ =10V, I <sub>D</sub> =25A	-	10.5	11.8	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	$V_{GS}$ =4.5V, I <sub>D</sub> =25A	-	13.5	16	mΩ
Forward Transconductance	<b>g</b> <sub>FS</sub>	V <sub>DS</sub> =5V,I <sub>D</sub> =25A	25	-	-	S
Dynamic Characteristics (Note4)	· · ·					
Input Capacitance	C <sub>lss</sub>	V <sub>DS</sub> =50V,V <sub>GS</sub> =0V,	-	2050	-	PF
Output Capacitance	C <sub>oss</sub>		-	180	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0MHz	-	21	-	PF
Switching Characteristics (Note 4)	· · ·					
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =50V,I <sub>D</sub> =25A	-	16	-	nS
Turn-on Rise Time	tr		-	18	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10V, $R_{G}$ =3 $\Omega$	-	32	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	10	-	nS
Total Gate Charge	Qg	V <sub>DS</sub> =50V,I <sub>D</sub> =25A,	-	42	-	nC
Gate-Source Charge	Q <sub>gs</sub>		-	7.8		nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	11		nC
Drain-Source Diode Characteristics			•			
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =25A	-		1.2	V
Diode Forward Current (Note 2)	I <sub>S</sub>		-	-	55	Α
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25°C, I <sub>F</sub> = 25A	-	45	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs <sup>(Note3)</sup>	-	95	-	nC

#### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board,  $t \le 10$  sec.
- 3. Pulse Test: Pulse Width ≤ 300 $\mu$ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production 5. EAS condition : Tj=25 $^\circ\!\!C,V_{DD}$ =50V,V\_G=10V,L=0.5mH,Rg=25 $\Omega$



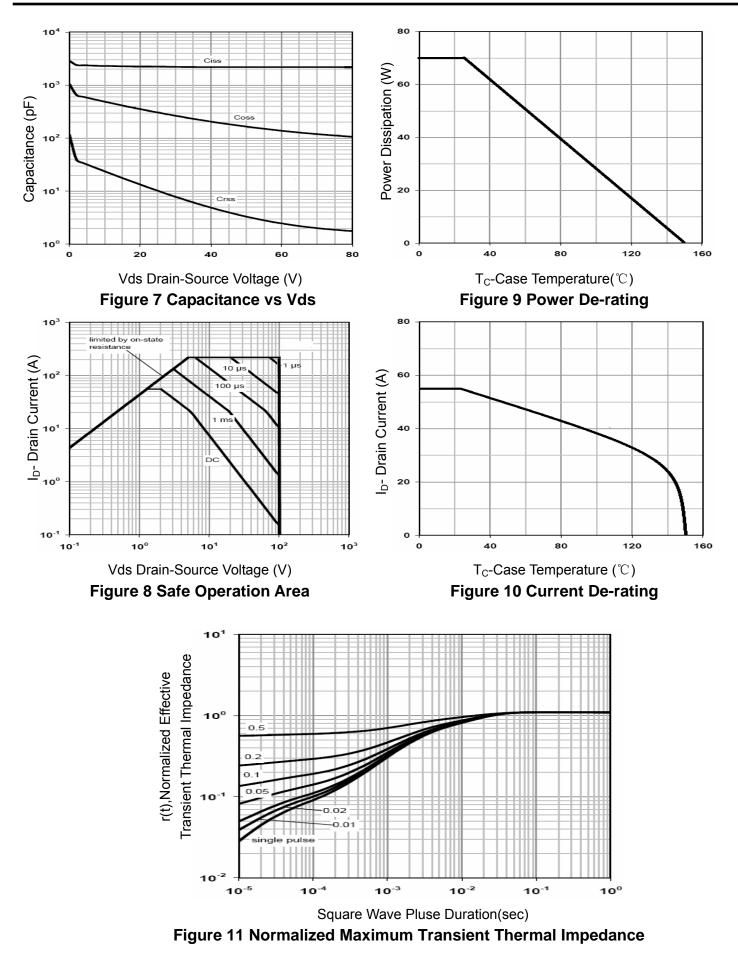
## **Typical Electrical and Thermal Characteristics**





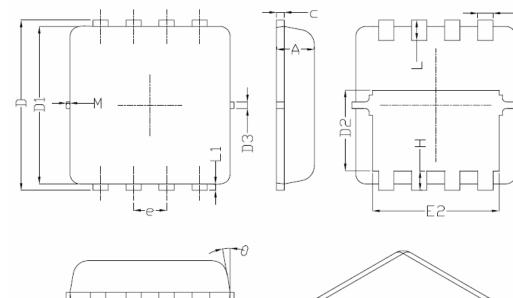
#### http://www.ncepower.com

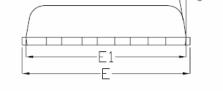
# NCEP11N10AQU

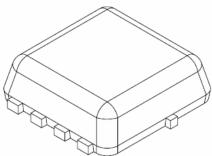




## DFN3.3X3.3-8L Package Information

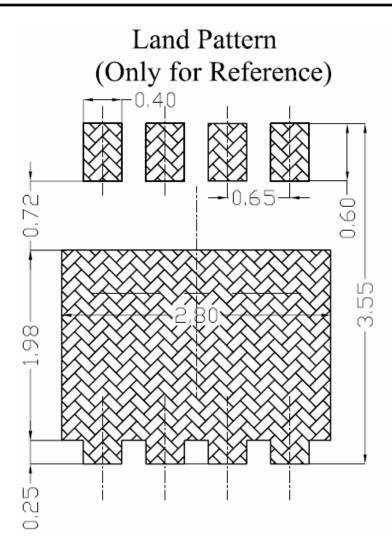






Symbol	Dimensions In Millimeters			
	Min.	Nom.	Max.	
A	0.70	0.75	0.80	
b	0.25	0.30	0.35	
с	0.10	0.15	0.25	
D	3.25	3.35	3.45	
D1	3.00	3.00 3.10		
D2	1.48	1.48 1.58		
D3	-	0.13	-	
E	3.20	3.30	3.40	
E1	3.00	3.00 3.15		
E2	2.39	2.49	2.59	
e	0.65BSC			
Н	0.30	0.39	0.50	
L	0.30	0.40	0.50	
L1	-	0.13	-	
М	*	*	0.15	
θ		10 <sup>°</sup>	12 <sup>°</sup>	







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